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PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

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October 5, 1993

pplliDant (): Iver E. ANDERSON, et al

: Pb-FREE Sn-Ag-Cu TERNARY EUTECTIC SOLDER

Serial No. : 08/094 854

Group : Unknown

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The Commissioner of Patents and Trademarks

Washington, D. C. 20231

Attention: Application Processing Division,

Special Processing and Correspondence Branch

sir:

RESPONSE

This is a response to the Patent Office communication mailed August 4, 1993, a copy of which is enclosed.

(Please see following pages.)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on October 5, 1993.

Respectfully submitted,

Edward J. Timmer

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